

具有使能功能的 TPS709 150mA、30V、1 μ A I_Q 稳压器

1 特性

- 超低 I_Q : 1 μ A
- 反向电流保护
- 低 $I_{\text{关断}}$: 150nA
- 输入电压范围 : 2.7 V 至 30 V
- 支持 200mA 峰值输出
- 在工作温度范围内的精度为 2%
- 可提供固定输出电压 : 1.2 V 至 6.5 V
- 热关断保护和过流保护
- 封装 : SOT-23-5、WSO-6

2 应用

- 烟雾和热量探测器
- 恒温器
- 运动检测器 (PIR、uWave 等)
- 无线电动工具
- 电器电池组
- 电表
- 水表

3 说明

TPS709 系列线性稳压器是设计用于功耗敏感类应用的超低静态电流器件。一个精密带隙和误差放大器在温度范围内的精度为 2%。只有 1 μ A 的静态电流使得此器件成为由电池供电、要求非常小闲置状态功率耗散的常开系统的理想解决方案。为了增加安全性，这些器件还具有热关断、电流限制和反向电流保护功能。

关断模式通过将 EN 引脚拉为低电平进行使能。该模式的关断电流低至 150nA (典型值)。

TPS709 系列采用 WSON-6 和 SOT-23-5 封装。

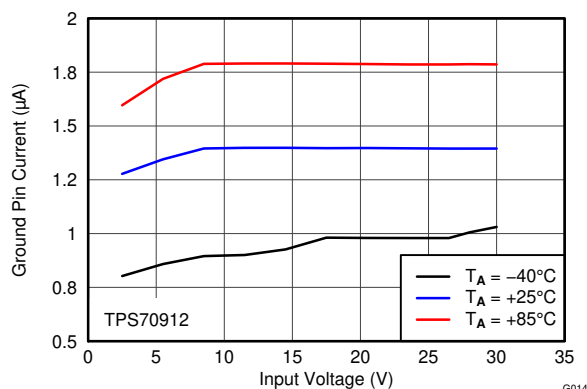
器件信息⁽¹⁾

器件型号	封装	封装尺寸 (标称值)
TPS709	SOT-23 (5)	2.90mm $\times$ 1.60mm
	WSON (6)	2.00mm $\times$ 2.00mm

(1) 如需了解所有可用封装，请参阅产品说明书末尾的封装选项附录。



典型应用电路



接地电流与 V_{IN} 和温度间的关系



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4 Revision History

注：以前版本的页码可能与当前版本的页码不同

Changes from Revision G (November 2015) to Revision H (July 2021)	Page
• 更新了整个文档中的表格、图和交叉参考的编号格式.....	1
• 更改了 <i>应用</i> 部分.....	1
• Changed $V_{EN(HI)}$ row (changed parameter description and added test condition) in <i>Electrical Characteristics</i> table.....	5
• Added $V_{EN(LOW)}$ row to <i>Electrical Characteristics</i> table.....	5
• Added M3 suffix information to <i>Device Nomenclature</i> table.....	17
Changes from Revision F (December 2014) to Revision G (November 2015)	Page
• Added DBV package for TPS709A to <i>Pin Configurations and Functions</i> section.....	3
• Added DBV package for TPS709B to <i>Pin Configurations and Functions</i> section.....	3
• Added TPS709A and TPS709B to Pin Functions table.....	3
• Moved operating junction temperature from <i>Electrical Characteristics</i> to <i>Recommended Operating Conditions</i>	4

5 Pin Configuration and Functions

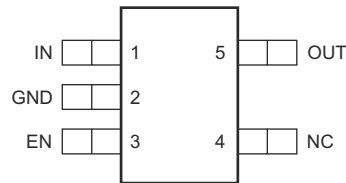


图 5-1. TPS709: DBV Package, 5-Pin SOT-23, Top View

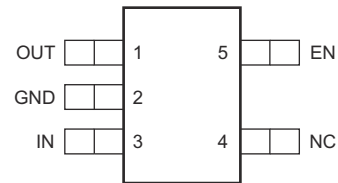


图 5-2. TPS709A: DBV Package, 5-Pin SOT-23, Top View

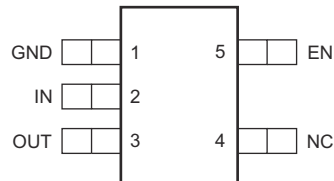


图 5-3. TPS709B: DBV Package, 5-Pin SOT-23, Top View

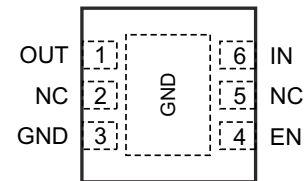


图 5-4. DRV Package, 6-Pin WSON, Top View

表 5-1. Pin Functions

PIN					I/O	DESCRIPTION
NAME	DRV	DBV				
	TPS709	TPS709	TPS709A	TPS709B		
EN	4	3	5	5	I	Enable pin. Drive this pin high to enable the device. Drive this pin low to put the device into low current shutdown. This pin can be left floating to enable the device. The maximum voltage must remain below 6.5 V.
GND	3	2	2	1	—	Ground
IN	6	1	3	2	I	Unregulated input to the device
NC	2, 5	4	4	4	—	No internal connection
OUT	1	5	1	3	O	Regulated output voltage. Connect a small 2.2-μF or greater ceramic capacitor from this pin to ground to assure stability.
Thermal pad		—	—	—	—	The thermal pad is electrically connected to the GND node. Connect this pad to the GND plane for improved thermal performance.

6 Specifications

6.1 Absolute Maximum Ratings

specified at $T_J = -40^{\circ}\text{C}$ to 125°C (unless otherwise noted); all voltages are with respect to GND⁽¹⁾

		MIN	MAX	UNIT
Voltage	V _{IN}	- 0.3	32	V
	V _{EN}	- 0.3	7	
	V _{OUT}	- 0.3	7	
Maximum output current	I _{OUT}	Internally limited		
Output short-circuit duration		Indefinite		
Continuous total power dissipation	P _{DISS}	See Thermal Information		
Operating junction temperature, T _J		- 55	150	°C
Storage temperature, T _{stg}		- 55	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	± 2000	V
		Charged device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾	± 500	

- (1) JEDEC document JEP155 states that 2-kV HBM allows safe manufacturing with a standard ESD control process.
 (2) JEDEC document JEP157 states that 500-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating junction temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
V_{IN}	Input voltage	2.7		30	V
V_{OUT}	Output voltage	1.2		6.5	V
V_{EN}	Enable voltage	0		6.5	V
T_J	Operating junction temperature	- 40		125	$^{\circ}\text{C}$

6.4 Thermal Information

THERMAL METRIC ⁽¹⁾		TPS709		UNIT
		DBV	DRV	
		5 PINS	6 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	212.1	73.1	$^{\circ}\text{C}/\text{W}$
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	78.5	97.0	$^{\circ}\text{C}/\text{W}$
$R_{\theta JB}$	Junction-to-board thermal resistance	39.5	42.6	$^{\circ}\text{C}/\text{W}$
ψ_{JT}	Junction-to-top characterization parameter	2.86	2.9	$^{\circ}\text{C}/\text{W}$
ψ_{JB}	Junction-to-board characterization parameter	38.7	42.9	$^{\circ}\text{C}/\text{W}$
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	N/A	12.8	$^{\circ}\text{C}/\text{W}$

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics application report](#).

6.5 Electrical Characteristics

at ambient temperature (T_A) = -40°C to $+85^{\circ}\text{C}$, $V_{IN} = V_{OUT(\text{typ})} + 1\text{ V}$ or 2.7 V (whichever is greater), $I_{OUT} = 1\text{ mA}$, $V_{EN} = 2\text{ V}$, and $C_{IN} = C_{OUT} = 2.2\text{-}\mu\text{F}$ ceramic (unless otherwise noted); typical values are at $T_A = 25^{\circ}\text{C}$

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_{IN}	Input voltage range		2.7		30	V
V_{OUT}	Output voltage range		1.2		6.5	V
V_{OUT}	DC output accuracy	$V_{OUT} < 3.3\text{ V}$	- 2%		2%	
		$V_{OUT} \geq 3.3\text{ V}$	- 1%		1%	
ΔV_{OUT}	Line regulation	$(V_{OUT(\text{nom})} + 1\text{ V}, 2.7\text{ V}) \leq V_{IN} \leq 30\text{ V}$		3	10	mV
	Load regulation	$V_{IN} = V_{OUT(\text{typ})} + 1.5\text{ V}$ or 3 V (whichever is greater), $100\text{ }\mu\text{A} \leq I_{OUT} \leq 150\text{ mA}$		20	50	
V_{DO}	Dropout voltage ^{(1) (3)}	TPS70933, $I_{OUT} = 50\text{ mA}$		295	650	mV
		TPS70933, $I_{OUT} = 150\text{ mA}$		960	1400	
		TPS70950, $I_{OUT} = 50\text{ mA}$		245	500	
		TPS70950, $I_{OUT} = 150\text{ mA}$		690	1200	
		TPS70965, $I_{OUT} = 50\text{ mA}$		180	500	
		TPS70965, $I_{OUT} = 150\text{ mA}$		460	1000	
$I_{(CL)}$	Output current limit ⁽⁴⁾	$V_{OUT} = 0.9 \times V_{OUT(\text{nom})}$	200	320	500	mA
I_{GND}	Ground pin current	$I_{OUT} = 0\text{ mA}$, $V_{OUT} \leq 3.3\text{ V}$		1.3	2.05	μA
		$I_{OUT} = 0\text{ mA}$, $V_{OUT} > 3.3\text{ V}$		1.4	2.25	
		$I_{OUT} = 150\text{ mA}$		350		
$I_{SHUTDOWN}$	Shutdown current	$V_{EN} \leq 0.4\text{ V}$, $V_{IN} = 2.7\text{ V}$		150		nA
PSRR	Power-supply rejection ratio	$f = 10\text{ Hz}$		80		dB
		$f = 100\text{ Hz}$		62		
		$f = 1\text{ kHz}$		52		
V_n	Output noise voltage	$\text{BW} = 10\text{ Hz to } 100\text{ kHz}$, $I_{OUT} = 10\text{ mA}$, $V_{IN} = 2.7\text{ V}$, $V_{OUT} = 1.2\text{ V}$		190		$\mu\text{ V}_{\text{RMS}}$
t_{STR}	Start-up time ⁽²⁾	$V_{OUT(\text{nom})} \leq 3.3\text{ V}$		200	600	μs
		$V_{OUT(\text{nom})} > 3.3\text{ V}$		500	1500	
$V_{EN(HI)}$	Enable pin high-level input voltage	Device enabled	0.9			V
$V_{EN(LOW)}$	Enable pin low-level input voltage	Device disabled	0		0.4	V
I_{EN}	EN pin current	$EN = 1.0\text{ V}$, $V_{IN} = 5.5\text{ V}$		300		nA
$I_{(REV)}$	Reverse current (flowing out of IN pin)	$V_{OUT} = 3\text{ V}$, $V_{IN} = V_{EN} = 0\text{ V}$		10		nA
	Reverse current (flowing into OUT pin)	$V_{OUT} = 3\text{ V}$, $V_{IN} = V_{EN} = 0\text{ V}$		100		
t_{SD}	Thermal shutdown temperature	Shutdown, temperature increasing		158		$^{\circ}\text{C}$
		Reset, temperature decreasing		140		

- (1) V_{DO} is measured with $V_{IN} = 0.98 \times V_{OUT(\text{nom})}$.
- (2) Start-up time = time from EN assertion to $0.95 \times V_{OUT(\text{nom})}$ and load = $47\text{ }\Omega$.
- (3) Dropout is only valid when $V_{OUT} \geq 2.8\text{ V}$ because of the minimum input voltage limits.
- (4) Measured with $V_{IN} = V_{OUT} + 3\text{ V}$ for $V_{OUT} \leq 2.5\text{ V}$. Measured with $V_{IN} = V_{OUT} + 2.5\text{ V}$ for $V_{OUT} > 2.5\text{ V}$.

6.6 Typical Characteristics

over operating temperature range ($T_J = -40^{\circ}\text{C}$ to 125°C), $I_{\text{OUT}} = 10\text{ mA}$, $V_{\text{EN}} = 2\text{ V}$, $C_{\text{OUT}} = 2.2\text{ }\mu\text{F}$, and $V_{\text{IN}} = V_{\text{OUT(typ)}} + 1\text{ V}$ or 2.7 V (whichever is greater), unless otherwise noted; typical values are at $T_J = 25^{\circ}\text{C}$

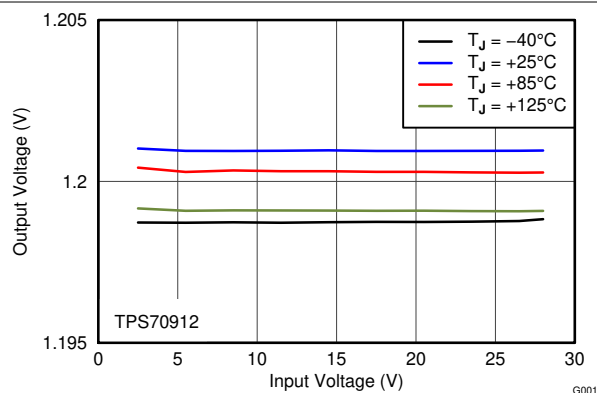


图 6-1. 1.2-V Line Regulation vs V_{IN} and Temperature

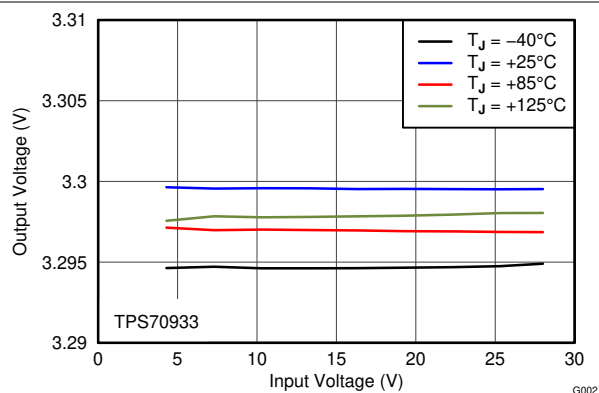


图 6-2. 3.3-V Line Regulation vs V_{IN} and Temperature

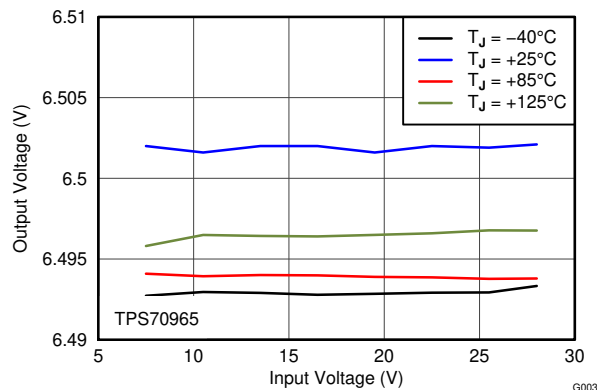


图 6-3. 6.5-V Line Regulation vs V_{IN} and Temperature

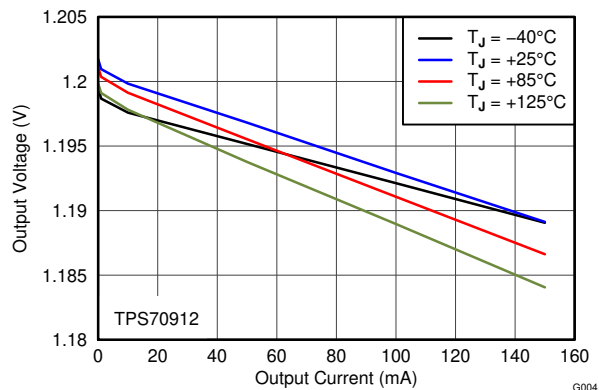


图 6-4. 1.2-V Load Regulation vs I_{OUT} and Temperature

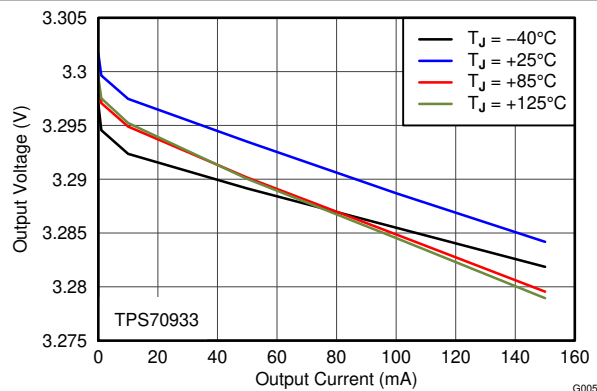


图 6-5. 3.3-V Load Regulation vs I_{OUT} and Temperature

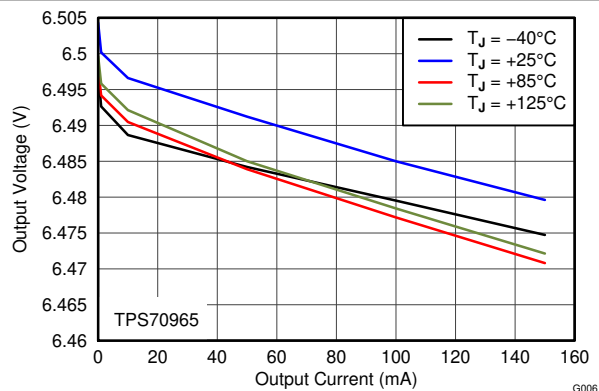


图 6-6. 6.5-V Load Regulation vs I_{OUT} and Temperature

6.6 Typical Characteristics (continued)

over operating temperature range ($T_J = -40^\circ\text{C}$ to 125°C), $I_{OUT} = 10\text{ mA}$, $V_{EN} = 2\text{ V}$, $C_{OUT} = 2.2\text{ }\mu\text{F}$, and $V_{IN} = V_{OUT(\text{typ})} + 1\text{ V}$ or 2.7 V (whichever is greater), unless otherwise noted; typical values are at $T_J = 25^\circ\text{C}$

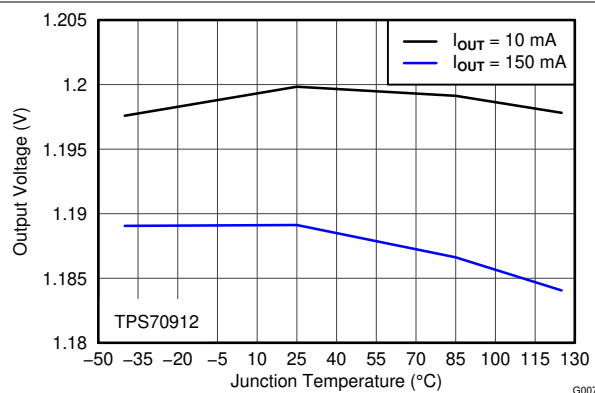


图 6-7. V_{OUT} vs Temperature

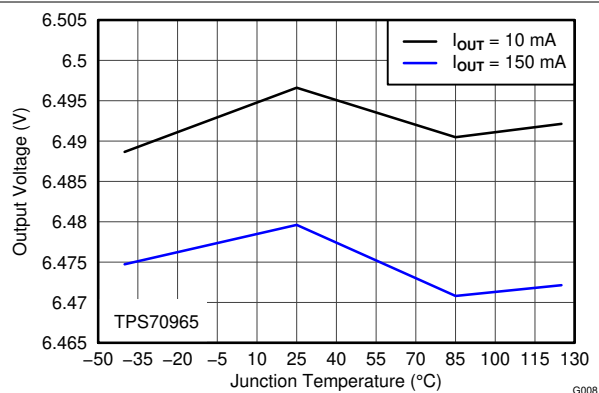


图 6-8. V_{OUT} vs Temperature

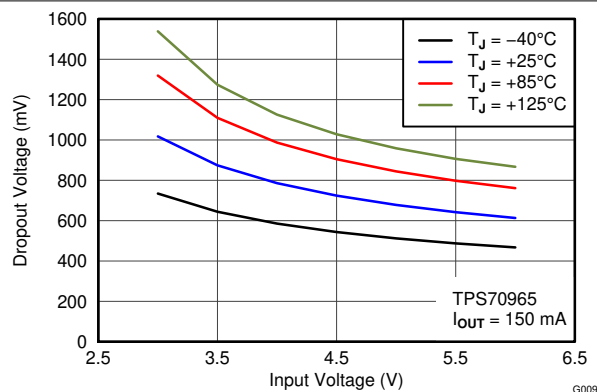


图 6-9. Dropout Voltage vs V_{IN} and Temperature

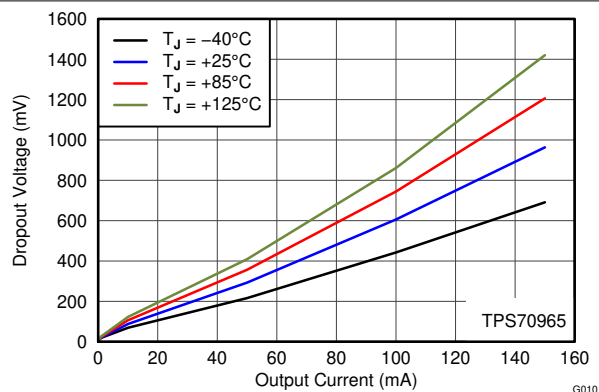


图 6-10. Dropout Voltage vs I_{OUT} and Temperature

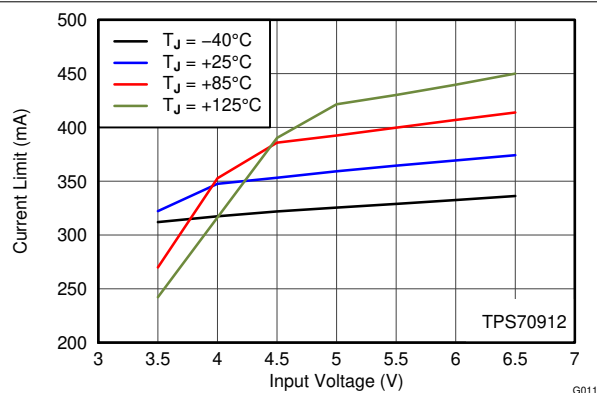


图 6-11. 1.2-V Current Limit vs V_{IN} and Temperature

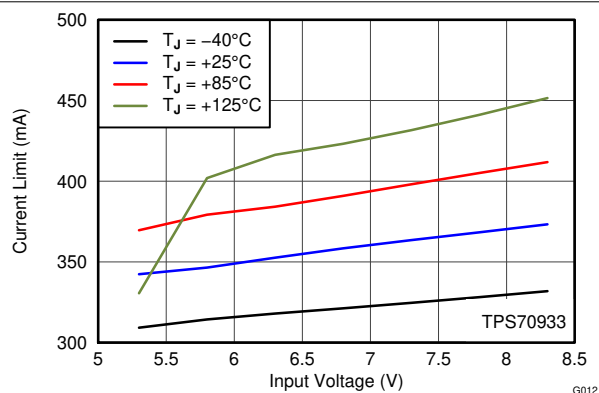


图 6-12. 3.3-V Current Limit vs V_{IN} and Temperature

6.6 Typical Characteristics (continued)

over operating temperature range ($T_J = -40^\circ\text{C}$ to 125°C), $I_{OUT} = 10\text{ mA}$, $V_{EN} = 2\text{ V}$, $C_{OUT} = 2.2\text{ }\mu\text{F}$, and $V_{IN} = V_{OUT(\text{typ})} + 1\text{ V}$ or 2.7 V (whichever is greater), unless otherwise noted; typical values are at $T_J = 25^\circ\text{C}$

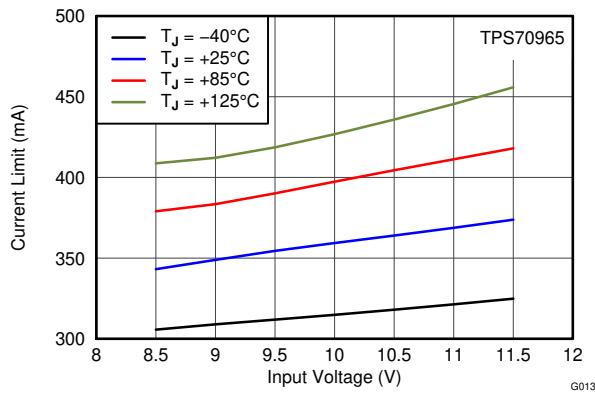


图 6-13. 6.5-V Current Limit vs V_{IN} and Temperature

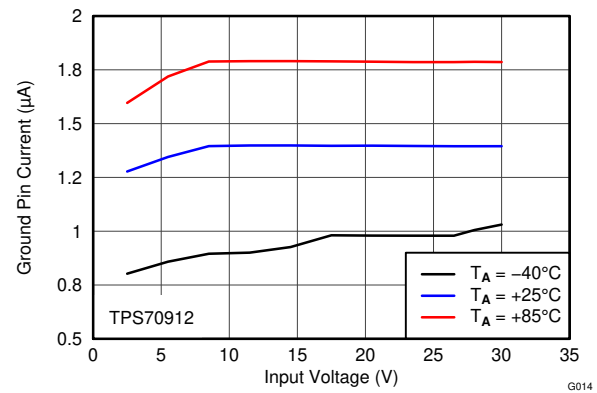


图 6-14. GND Current vs V_{IN} and Temperature

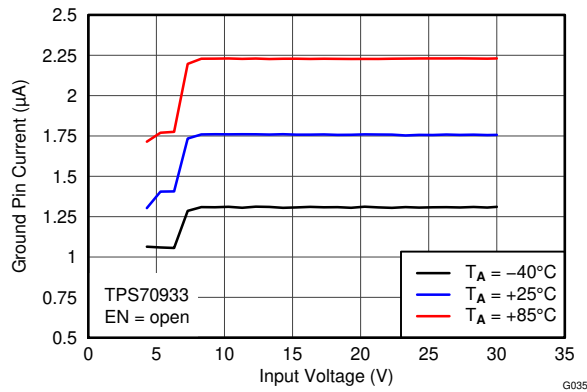


图 6-15. GND Current vs V_{IN} and Temperature

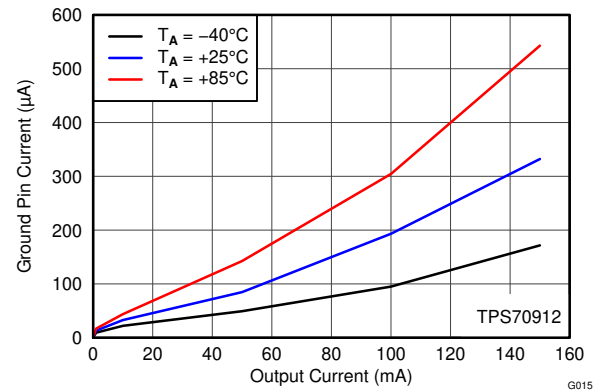


图 6-16. GND Current vs I_{OUT} and Temperature

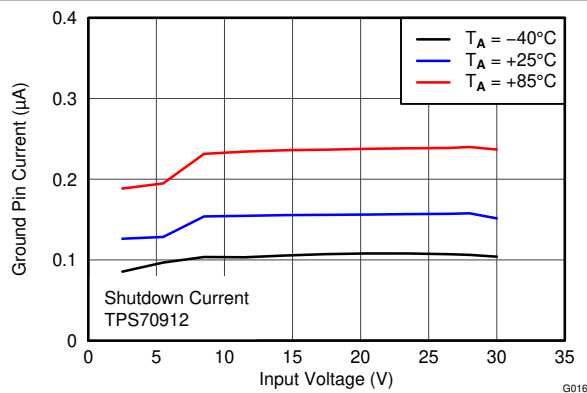


图 6-17. Shutdown Current vs V_{IN} and Temperature

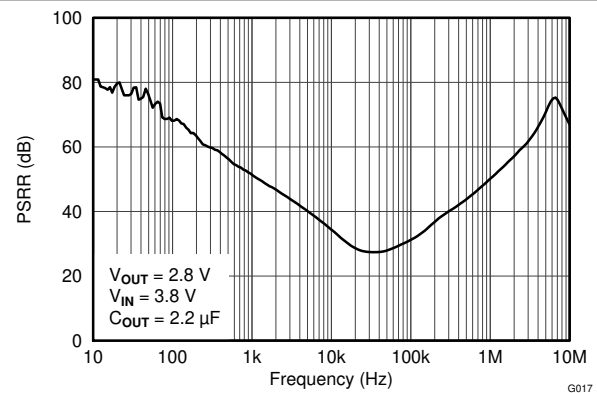


图 6-18. Power-Supply Rejection Ratio vs Frequency

6.6 Typical Characteristics (continued)

over operating temperature range ($T_J = -40^{\circ}\text{C}$ to 125°C), $I_{\text{OUT}} = 10\text{ mA}$, $V_{\text{EN}} = 2\text{ V}$, $C_{\text{OUT}} = 2.2\text{ }\mu\text{F}$, and $V_{\text{IN}} = V_{\text{OUT(typ)}} + 1\text{ V}$ or 2.7 V (whichever is greater), unless otherwise noted; typical values are at $T_J = 25^{\circ}\text{C}$

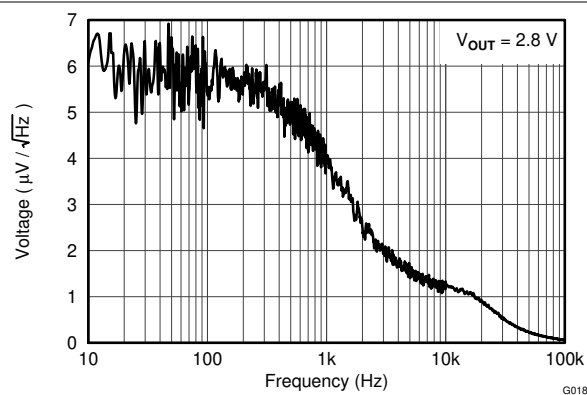


图 6-19. Noise

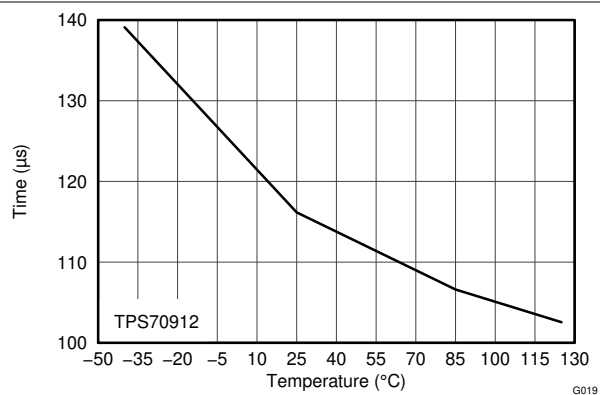


图 6-20. Start-Up Time vs Temperature

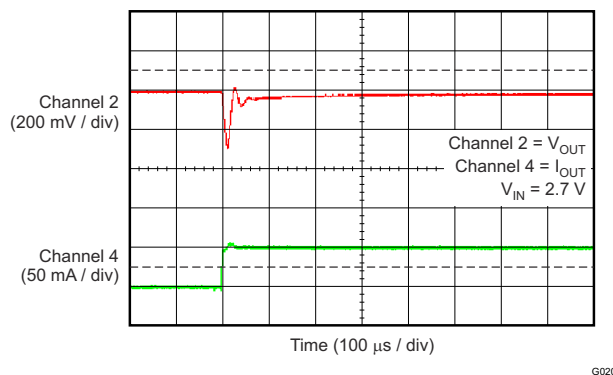


图 6-21. TPS70912 Load Transient
(0 mA to 50 mA)

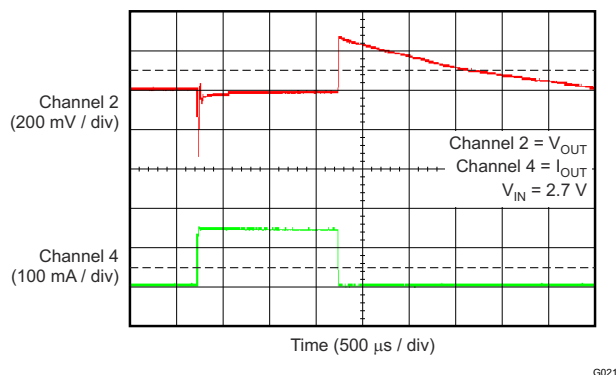


图 6-22. TPS70912 Load Transient
(1 mA to 150 mA)

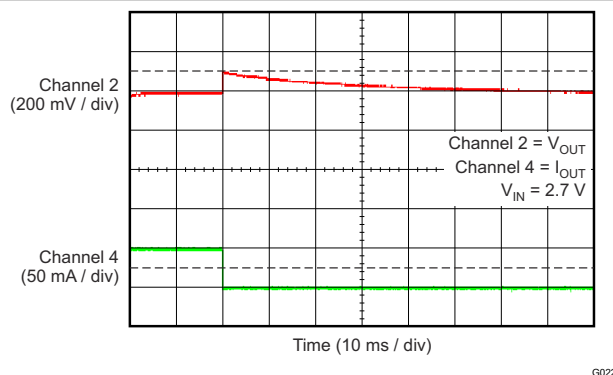


图 6-23. TPS70912 Load Transient
(50 mA to 0 mA)

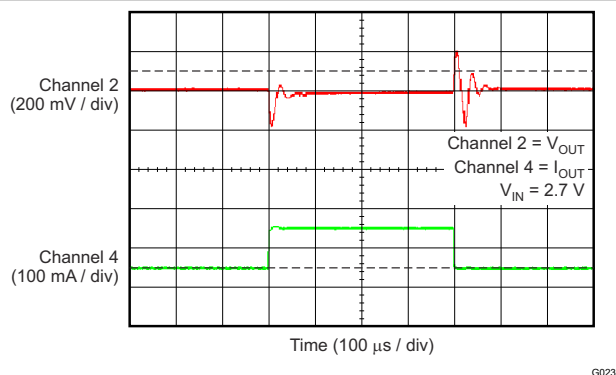


图 6-24. TPS70912 Load Transient
(50 mA to 150 mA)

6.6 Typical Characteristics (continued)

over operating temperature range ($T_J = -40^{\circ}\text{C}$ to 125°C), $I_{\text{OUT}} = 10\text{ mA}$, $V_{\text{EN}} = 2\text{ V}$, $C_{\text{OUT}} = 2.2\text{ }\mu\text{F}$, and $V_{\text{IN}} = V_{\text{OUT}(\text{typ})} + 1\text{ V}$ or 2.7 V (whichever is greater), unless otherwise noted; typical values are at $T_J = 25^{\circ}\text{C}$

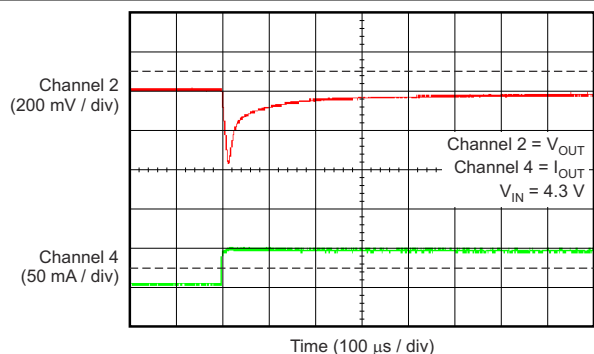


图 6-25. TPS70933 Load Transient
(0 mA to 50 mA)

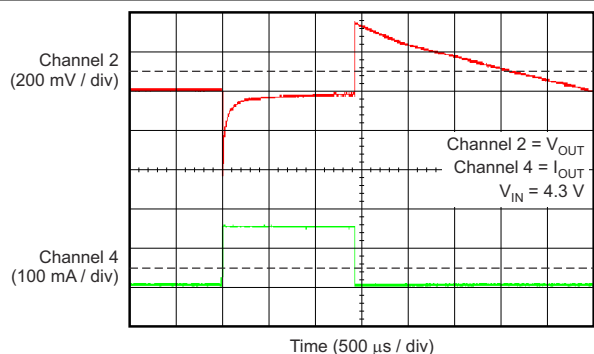


图 6-26. TPS70933 Load Transient
(1 mA to 150 mA)

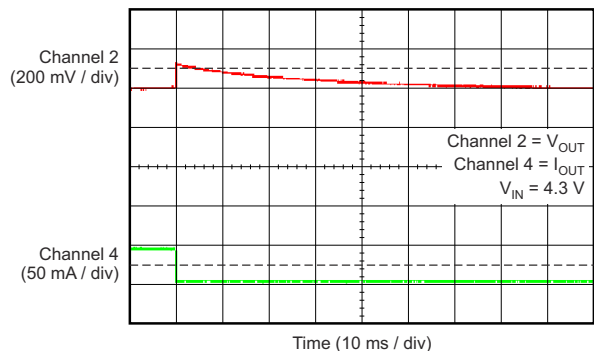


图 6-27. TPS70933 Load Transient
(50 mA to 0 mA)

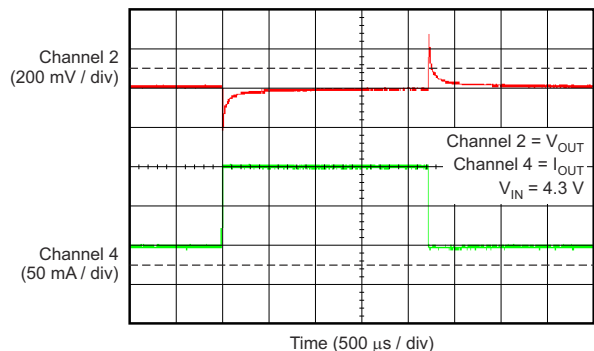


图 6-28. TPS70933 Load Transient
(50 mA to 150 mA)

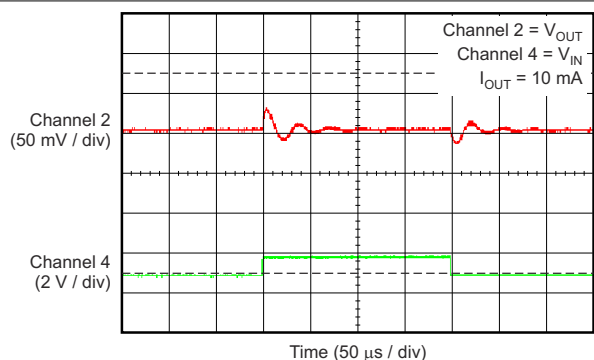


图 6-29. TPS70912 Line Transient
(2.7 V to 3.7 V)

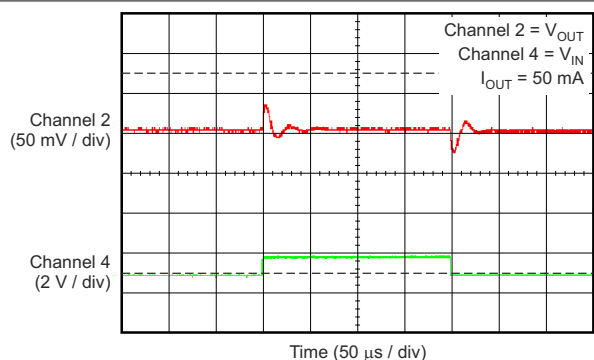


图 6-30. TPS70912 Line Transient
(2.7 V to 3.7 V)

6.6 Typical Characteristics (continued)

over operating temperature range ($T_J = -40^{\circ}\text{C}$ to 125°C), $I_{OUT} = 10\text{ mA}$, $V_{EN} = 2\text{ V}$, $C_{OUT} = 2.2\text{ }\mu\text{F}$, and $V_{IN} = V_{OUT(\text{typ})} + 1\text{ V}$ or 2.7 V (whichever is greater), unless otherwise noted; typical values are at $T_J = 25^{\circ}\text{C}$

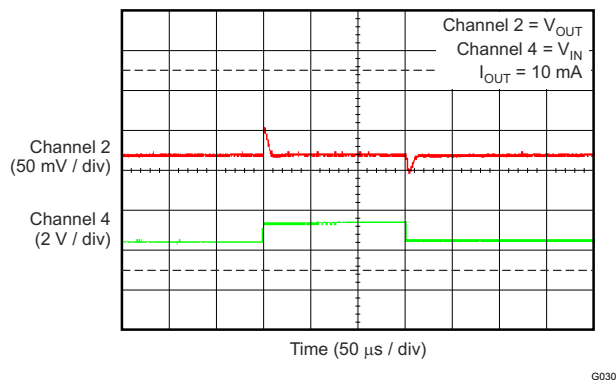


图 6-31. TPS70933 Line Transient (4.3 V to 5.3 V)

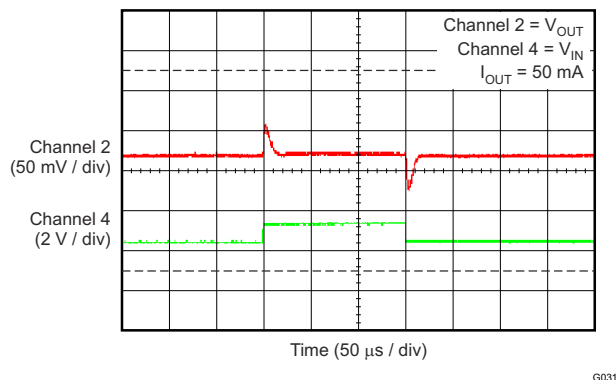


图 6-32. TPS70933 Line Transient (4.3 V to 5.3 V)

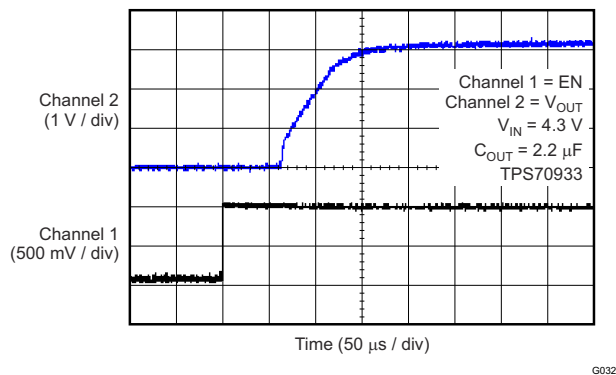


图 6-33. Power-Up With Enable

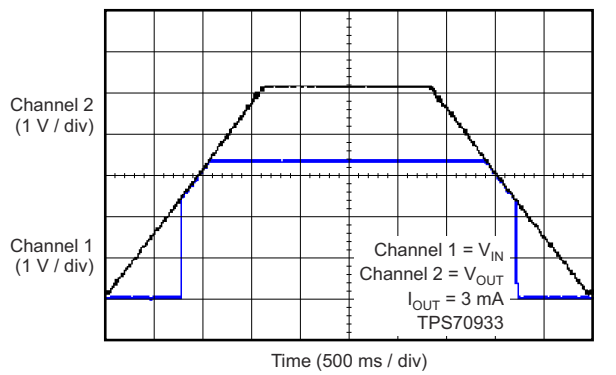


图 6-34. Power-Up and Power-Down Response

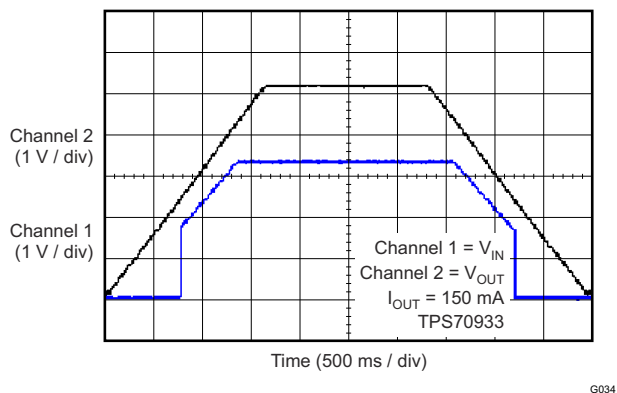


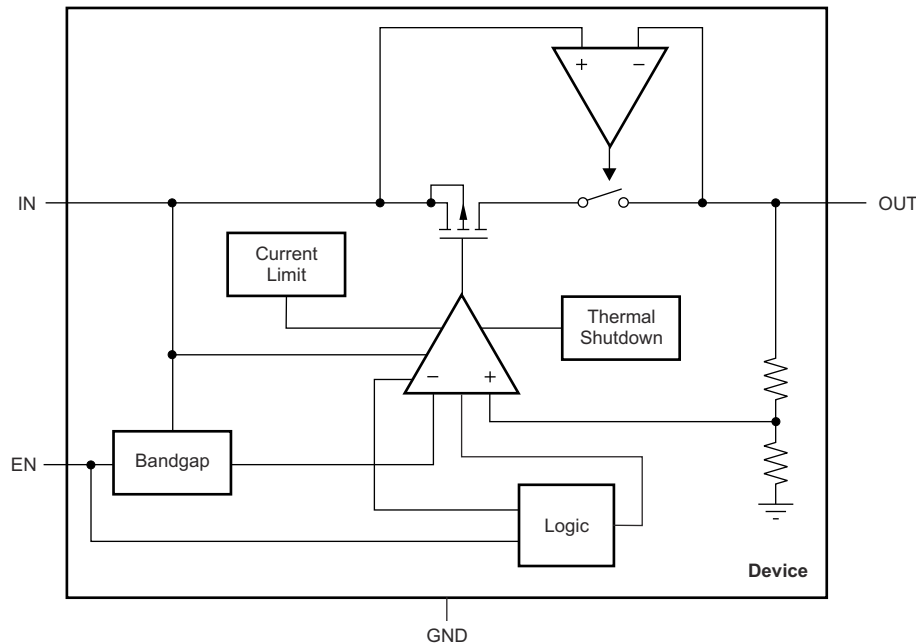
图 6-35. Power-Up and Power-Down Response

7 Detailed Description

7.1 Overview

The TPS709 series of devices are ultra-low quiescent current, low-dropout (LDO) linear regulators. The TPS709 offers reverse current protection to block any discharge current from the output into the input. The TPS709 also features current limit and thermal shutdown for reliable operation.

7.2 Functional Block Diagram



7.3 Feature Description

7.3.1 Internal Current Limit

The TPS709 internal current limit helps protect the regulator during fault conditions. During current limit, the output sources a fixed amount of current that is largely independent of output voltage. In such a case, the output voltage is not regulated, and can be measured as $V_{OUT} = I_{LIMIT} \times R_{LOAD}$. The PMOS pass transistor dissipates $[(V_{IN} - V_{OUT}) \times I_{LIMIT}]$ until a thermal shutdown is triggered and the device turns off. When cool, the device is turned on by the internal thermal shutdown circuit. If the fault condition continues, the device cycles between current limit and thermal shutdown; see the [Thermal Protection](#) section for more details.

The TPS709 is characterized over the recommended operating output current range up to 150 mA. The internal current limit begins to limit the output current at a minimum of 200 mA of output current. The TPS709 continues to operate for output currents between 150 mA and 200 mA but some data sheet parameters may not be met.

7.3.2 Dropout Voltage

The TPS709 use a PMOS pass transistor to achieve low dropout voltage. When $(V_{IN} - V_{OUT})$ is less than the dropout voltage (V_{DO}), the PMOS pass device is in the linear region of operation and the input-to-output resistance is the $R_{DS(ON)}$ of the PMOS pass element. V_{DO} approximately scales with the output current because the PMOS device functions like a resistor in dropout.

The ground pin current of many linear voltage regulators increases substantially when the device is operated in dropout. This increase in ground pin current while operating in dropout can be several orders of magnitude larger than when the device is not in dropout. The TPS709 employs a special control loop that limits the increase in ground pin current while operating in dropout. This functionality allows for the most efficient operation while in dropout conditions that can greatly increase battery run times.

7.3.3 Undervoltage Lockout (UVLO)

The TPS709 uses an undervoltage lockout (UVLO) circuit to keep the output shut off until the internal circuitry operates properly.

7.3.4 Reverse-Current Protection

The TPS709 has integrated reverse-current protection. Reverse-current protection prevents the flow of current from the OUT pin to the IN pin when output voltage is higher than input voltage. The reverse-current protection circuitry places the power path in high impedance when the output voltage is higher than the input voltage. This setting reduces leakage current from the output to the input to 10 nA, typical. The reverse current protection is always active regardless of the enable pin logic state or if the OUT pin voltage is greater than 1.8 V. Reverse current can flow if the output voltage is less than 1.8 V and if input voltage is less than the output voltage.

If voltage is applied to the input pin, then the maximum voltage that can be applied to the OUT pin is the lower of three times the nominal output voltage or 6.5 V. For example, if the 1.2-V output voltage version is used, then the maximum reverse bias voltage that can be applied to the OUT pin is 3.6 V. If the 5.0-V output voltage version is used, then the maximum reverse bias voltage that can be applied to the OUT pin is 6.5 V.

7.4 Device Functional Modes

The TPS709 has the following functional modes:

1. **Enabled:** When the enable pin (EN) goes above 0.9 V, the device is enabled. EN is pulled high by a 300-nA current source; therefore, EN can be left floating to enable the device. Do not connect EN to VIN. The EN pin is clamped by a 6.5-V Zener diode. Do not exceed the 7-V absolute maximum rating on the enable pin or excessive current flowing into the Zener clamp will destroy the device.
2. **Disabled:** When EN goes below 0.4 V, the device is disabled. During this time, OUT is high impedance and the current into IN (I_{SHUTDOWN}) is typically 150 nA.

8 Application and Implementation

Note

以下应用部分中的信息不属于 TI 器件规格的范围，TI 不担保其准确性和完整性。TI 的客户应负责确定器件是否适用于其应用。客户应验证并测试其设计，以确保系统功能。

8.1 Application Information

The TPS709 is a series of devices that consume low quiescent current and deliver excellent line and load transient performance. This performance, combined with low noise and very good PSRR with little ($V_{IN} - V_{OUT}$) headroom, makes this device ideal for RF portable applications, current limit, and thermal protection. The TPS709 is specified from -40°C to $+125^{\circ}\text{C}$.

8.1.1 Input and Output Capacitor

The TPS709 devices are stable with output capacitors with an effective capacitance of $2.0\ \mu\text{F}$ or greater for output voltages below 1.5 V. For output voltages equal or greater than 1.5 V, the minimum effective capacitance for stability is $1.5\ \mu\text{F}$. The maximum capacitance for stability is $47\ \mu\text{F}$. The equivalent series resistance (ESR) of the output capacitor must be between $0\ \Omega$ and $0.2\ \Omega$ for stability.

The effective capacitance is the minimum capacitance value of a capacitor after taking into account variations resulting from tolerances, temperature, and dc bias effects. X5R- and X7R-type ceramic capacitors are recommended because these capacitors have minimal variation in value and ESR over temperature.

Although an input capacitor is not required for stability, good analog design practice is to connect a $0.1\text{-}\mu\text{F}$ to $2.2\text{-}\mu\text{F}$ capacitor from IN to GND. This capacitor counteracts reactive input sources and improves transient response, input ripple, and PSRR. An input capacitor is necessary if line transients greater than 10 V in magnitude are anticipated.

8.1.2 Transient Response

As with any regulator, increasing the output capacitor size reduces over- and undershoot magnitude, but increases transient response duration.

8.2 Typical Application

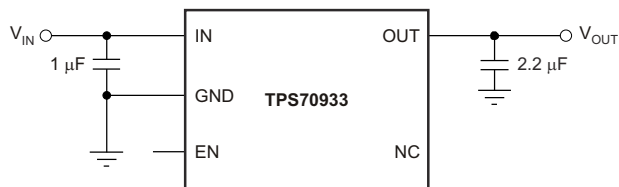


图 8-1. Wide Input, 3.3-V, Low- I_Q Rail

8.2.1 Design Requirements

表 8-1 summarizes the design requirements for 图 8-1.

表 8-1. Design Requirements for a Wide Input, 3.3-V, Low- I_Q Rail Application

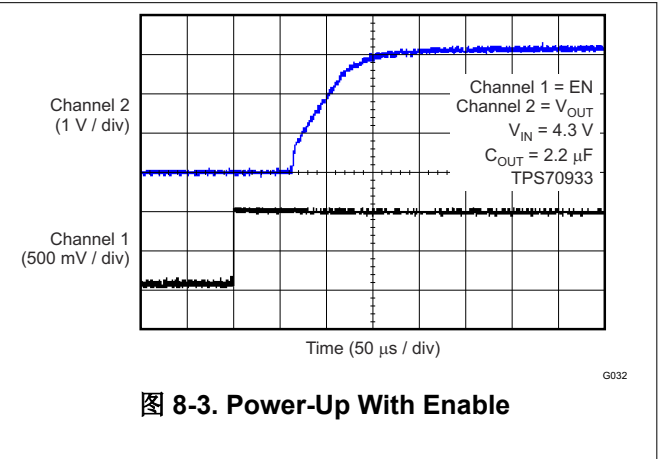
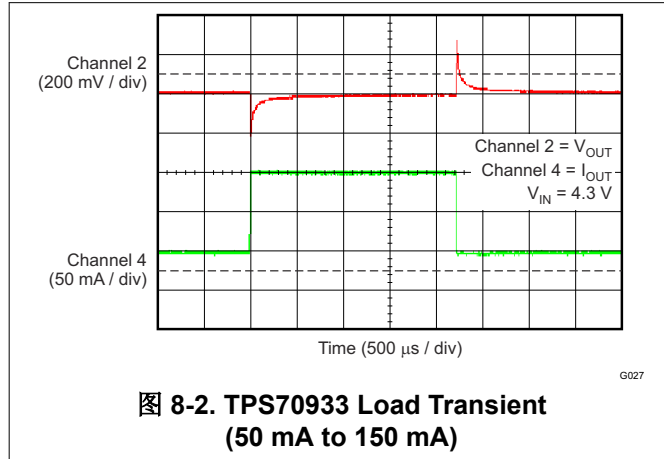
PARAMETER	DESIGN SPECIFICATION
V_{IN}	5 V to 20 V
V_{OUT}	3.3 V
$I_{(IN)}$ (no load)	$< 5\ \mu\text{A}$
I_{OUT} (max)	150 mA

8.2.2 Detailed Design Procedure

Select a 2.2-μF, 10-V X7R output capacitor to satisfy the minimum output capacitance requirement with a 3.3-V dc bias.

Select a 1.0-μF, 25-V X7R input capacitor to provide input noise filtering and eliminate high-frequency voltage transients.

8.2.3 Application Curves



9 Power Supply Recommendations

This device is designed to operate with an input supply range of 2.7 V to 30 V. If the input supply is noisy, additional input capacitors with low ESR can help improve output noise performance.

9.1 Power Dissipation

The ability to remove heat from the die is different for each package type, presenting different considerations in the printed circuit board (PCB) layout. The PCB area around the device that is free of other components moves the heat from the device to ambient air. Performance data for JEDEC low and high-K boards are given in the [Thermal Information](#) table. Using heavier copper increases the effectiveness in removing heat from the device. The addition of plated through-holes to heat-dissipating layers also improves the heat sink effectiveness.

Power dissipation depends on input voltage and load conditions. Power dissipation (P_{DISS}) is equal to the product of the output current and the voltage drop across the output pass element, as shown in [方程式 1](#):

$$P_{DISS} = (V_{IN} - V_{OUT}) \times I_{OUT} \quad (1)$$

10 Layout

10.1 Layout Guidelines

Place input and output capacitors as close to the device pins as possible. To improve ac performance (such as PSRR, output noise, and transient response), TI recommends that the board be designed with separate ground planes for V_{IN} and V_{OUT} , with the ground plane connected only at the GND pin of the device. In addition, the ground connection for the output capacitor must be connected directly to the device GND pin.

10.1.1 Thermal Protection

Thermal protection disables the output when the junction temperature rises to approximately 165°C, allowing the device to cool. When the junction temperature cools to approximately 145°C, the output circuitry is again enabled. Depending on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit can cycle on and off. This cycling limits the dissipation of the regulator, protecting it from damage as a result of overheating.

Any tendency to activate the thermal protection circuit indicates excessive power dissipation or an inadequate heat sink. For reliable operation, limit junction temperature to 125°C, maximum. To estimate the margin of safety in a complete design (including heat sink), increase the ambient temperature until the thermal protection is triggered; use worst-case loads and signal conditions. For good reliability, thermal protection must trigger at least 35°C above the maximum expected ambient condition of the particular application. This configuration produces a worst-case junction temperature of 125°C at the highest expected ambient temperature and worst-case load.

The TPS709 internal protection circuitry is designed to protect against overload conditions. This circuitry is not intended to replace proper heat sinking. Continuously running the TPS709 into thermal shutdown degrades device reliability.

10.2 Layout Example

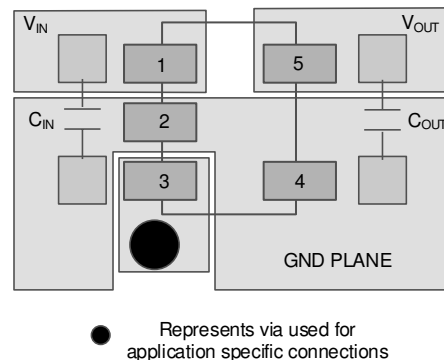


图 10-1. Layout Example for DBV Package

11 Device and Documentation Support

11.1 Device Support

11.1.1 Development Support

11.1.1.1 Evaluation Modules

An evaluation module (EVM) is available to assist in the initial circuit performance evaluation using the TPS709xx. The [TPS70933EVM-110 evaluation module](#) (and [related user guide](#)) can be requested at the Texas Instruments website through the product folders or purchased directly from the [TI eStore](#).

11.1.1.2 Spice Models

Computer simulation of circuit performance using SPICE is often useful when analyzing the performance of analog circuits and systems. A SPICE model for the TPS709 is available through the product folders under *Simulation Models*.

11.1.2 Device Nomenclature

表 11-1. Device Nomenclature⁽¹⁾

PRODUCT	V _{OUT}
TPS709xx(x) yyy z or TPS709xx(x) yyy zM3	XX(X) is the nominal output voltage. For output voltages with a resolution of 100 mV, two digits are used in the ordering number; otherwise, three digits are used (for example, 28 = 2.8 V; 125 = 1.25 V). YYY is the package designator. Z is the tape and reel quantity (R = 3000, T = 250). M3 suffix device has same electrical specs as other devices and shares same design.

(1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](#).

11.2 Documentation Support

11.2.1 Related Documentation

For related documentation see the following:

Texas Instruments, [TPS70933EVM-110 Evaluation Module user guide](#)

11.3 支持资源

[TI E2E™ 支持论坛](#)是工程师的重要参考资料，可直接从专家获得快速、经过验证的解答和设计帮助。搜索现有解答或提出自己的问题可获得所需的快速设计帮助。

链接的内容由各个贡献者“按原样”提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的《使用条款》。

11.4 Trademarks

TI E2E™ is a trademark of Texas Instruments.

所有商标均为其各自所有者的财产。

11.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

11.6 术语表

TI 术语表

本术语表列出并解释了术语、首字母缩略词和定义。

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS70912DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SCX
TPS70912DBVR.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SCX
TPS70912DBVT	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SCX
TPS70912DBVT.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SCX
TPS70912DRVR	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SCX
TPS70912DRVR.Z	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SCX
TPS70912DRVT	Active	Production	WSON (DRV) 6	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SCX
TPS70912DRVT.Z	Active	Production	WSON (DRV) 6	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SCX
TPS709135DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SCY
TPS709135DBVR.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SCY
TPS709135DBVT	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SCY
TPS709135DBVT.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SCY
TPS70915DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIM
TPS70915DBVR.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIM
TPS70915DBVT	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIM
TPS70915DBVT.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIM
TPS70915DRVR	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIM
TPS70915DRVR.Z	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIM
TPS70915DRVT	Active	Production	WSON (DRV) 6	250 SMALL T&R	Yes	NIPDAU NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIM
TPS70915DRVT.Z	Active	Production	WSON (DRV) 6	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIM
TPS70915DRVTG4.Z	Active	Production	WSON (DRV) 6	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIM
TPS70916DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SCZ
TPS70916DBVR.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SCZ
TPS70916DBVT	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SCZ
TPS70916DBVT.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SCZ
TPS70918DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDA
TPS70918DBVR.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDA
TPS70918DBVT	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDA
TPS70918DBVT.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDA

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS70918DBVTG4.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDA
TPS70918DRV.R	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDA
TPS70918DRV.R.Z	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDA
TPS70918DRV.RG4.Z	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDA
TPS70918DRV.RM3	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDA
TPS70918DRV.T	Active	Production	WSON (DRV) 6	250 SMALL T&R	Yes	NIPDAU NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDA
TPS70918DRV.T.Z	Active	Production	WSON (DRV) 6	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDA
TPS70919DBV.R	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU SN NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDB
TPS70919DBV.R.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDB
TPS70919DBV.RG4.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	-	Call TI	Call TI	-40 to 125	
TPS70919DBV.T	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU SN NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDB
TPS70919DBV.T.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDB
TPS70925DBV.R	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU SN	Level-1-260C-UNLIM	-40 to 125	SDC
TPS70925DBV.R.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	SDC
TPS70925DBV.RG4.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	-	Call TI	Call TI	-40 to 125	
TPS70925DBV.T	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDC
TPS70925DBV.T.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDC
TPS70925DRV.R	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDC
TPS70925DRV.R.Z	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDC
TPS70925DRV.T	Active	Production	WSON (DRV) 6	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDC
TPS70925DRV.T.Z	Active	Production	WSON (DRV) 6	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDC
TPS70927DBV.R	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDD
TPS70927DBV.R.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDD
TPS70927DBV.T	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDD
TPS70927DBV.T.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDD
TPS70928DBV.R	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU SN	Level-1-260C-UNLIM	-40 to 125	SDE
TPS70928DBV.R.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	SDE
TPS70928DBV.T	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDE
TPS70928DBV.T.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDE
TPS70930DBV.R	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU SN NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDF
TPS70930DBV.R.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDF

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS70930DBVRG4.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	-	Call TI	Call TI	-40 to 125	
TPS70930DBVT	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU SN NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDF
TPS70930DBVT.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDF
TPS70930DRV	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDF
TPS70930DRV.R.Z	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDF
TPS70930DRV.RG4.Z	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDF
TPS70930DRV	Active	Production	WSON (DRV) 6	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDF
TPS70930DRV.T.Z	Active	Production	WSON (DRV) 6	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDF
TPS70933DBV	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU SN NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDG
TPS70933DBV.R.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDG
TPS70933DBVRG4.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDG
TPS70933DBV	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU SN NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDG
TPS70933DBV.T.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDG
TPS70933DRV	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDG
TPS70933DRV.R.Z	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDG
TPS70933DRV.RG4.Z	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDG
TPS70933DRV	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDG
TPS70933DRV	Active	Production	WSON (DRV) 6	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDG
TPS70933DRV.T.Z	Active	Production	WSON (DRV) 6	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDG
TPS70936DBV	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU SN NIPDAU	Level-1-260C-UNLIM	-40 to 125	SEJ
TPS70936DBV.R.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SEJ
TPS70936DBV	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU SN NIPDAU	Level-1-260C-UNLIM	-40 to 125	SEJ
TPS70936DBV.T.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SEJ
TPS70936DRV	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	1FV
TPS70936DRV.R.Z	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	1FV
TPS70936DRV	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	1FV
TPS70938DBV	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIC
TPS70938DBV.R.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIC
TPS70938DBV	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIC
TPS70938DBV.T.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIC
TPS70938DBVTG4.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIC

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS70939DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SID
TPS70939DBVR.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SID
TPS70939DBVT	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SID
TPS70939DBVT.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SID
TPS70950DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU SN NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDH
TPS70950DBVR.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDH
TPS70950DBVRG4.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDH
TPS70950DBVT	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU SN NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDH
TPS70950DBVT.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDH
TPS70950DRVVR	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDH
TPS70950DRVVR.Z	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDH
TPS70950DRVVRG4.Z	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDH
TPS70950DRVVRM3	Active	Production	WSON (DRV) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDH
TPS70950DRVVT	Active	Production	WSON (DRV) 6	250 SMALL T&R	Yes	NIPDAU NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDH
TPS70950DRVVT.Z	Active	Production	WSON (DRV) 6	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SDH
TPS70960DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIT
TPS70960DBVR.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIT
TPS70960DBVRG4.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIT
TPS70960DBVT	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIT
TPS70960DBVT.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIT
TPS709A30DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	11RF
TPS709A30DBVR.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	11RF
TPS709A30DBVT	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	11RF
TPS709A30DBVT.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	11RF
TPS709A33DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU SN	Level-1-260C-UNLIM	-40 to 125	11SF
TPS709A33DBVR.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	11SF
TPS709A33DBVRG4.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	-	Call TI	Call TI	-40 to 125	
TPS709A33DBVT	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	11SF
TPS709A33DBVT.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	11SF
TPS709B33DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	13C7
TPS709B33DBVR.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	13C7

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS709B33DBVT	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	13C7
TPS709B33DBVT.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	13C7
TPS709B345DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	1XSW
TPS709B345DBVR.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	1XSW
TPS709B50DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	13D7
TPS709B50DBVR.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	13D7
TPS709B50DBVRG4.Z	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	13D7
TPS709B50DBVT	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	13D7
TPS709B50DBVT.Z	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	13D7

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF TPS709 :

- Automotive : [TPS709-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

TAPE AND REEL INFORMATION



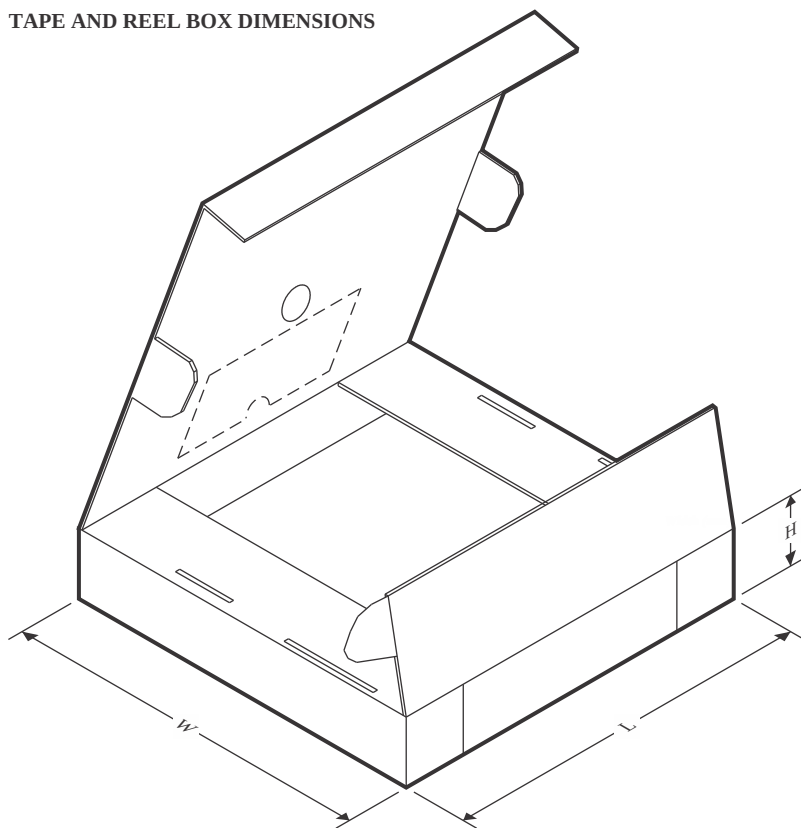
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS70912DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS70912DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS70912DRVR	WSO	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70912DRV	WSO	DRV	6	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS709135DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS709135DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS70915DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS70915DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS70915DRVR	WSO	DRV	6	3000	179.0	8.4	2.2	2.2	1.2	4.0	8.0	Q2
TPS70915DRVT	WSO	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70915DRV	WSO	DRV	6	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70915DRV	WSO	DRV	6	250	179.0	8.4	2.2	2.2	1.2	4.0	8.0	Q2
TPS70916DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS70916DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS70918DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS70918DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS70918DRVR	WSO	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70918DRVRM3	WSO	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70918DRVT	WSO	DRV	6	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70919DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70919DBVT	SOT-23	DBV	5	250	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70925DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70925DBVT	SOT-23	DBV	5	250	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS70925DRVR	WSO	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70925DRVT	WSO	DRV	6	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70927DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS70927DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS70928DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70928DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS70930DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70930DBVT	SOT-23	DBV	5	250	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70930DRVR	WSO	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70930DRVT	WSO	DRV	6	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70933DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS70933DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70933DBVT	SOT-23	DBV	5	250	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70933DRVR	WSO	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70933DRVRM3	WSO	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70933DRVT	WSO	DRV	6	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70936DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70936DBVT	SOT-23	DBV	5	250	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70936DBVT	SOT-23	DBV	5	250	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70936DRVR	WSO	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70936DRVRM3	WSO	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70938DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS70938DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS70939DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS70939DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS70950DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70950DBVT	SOT-23	DBV	5	250	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70950DRVR	WSO	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70950DRVRM3	WSO	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70950DRVT	WSO	DRV	6	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70960DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS70960DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS709A30DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS709A30DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS709A33DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS709A33DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS709B33DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS709B33DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS709B345DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS709B50DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS709B50DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

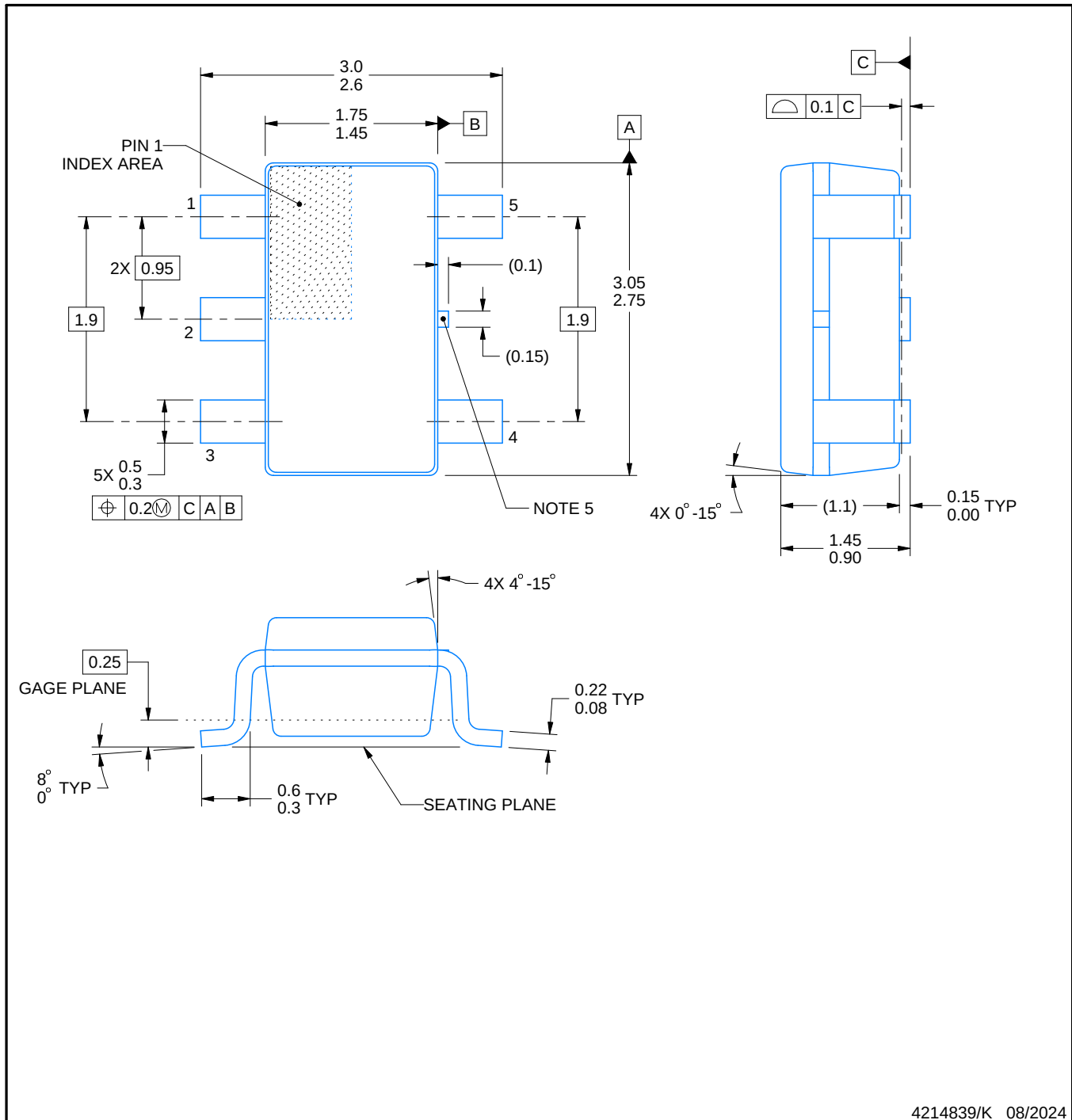
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS70912DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS70912DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70912DRVR	WSON	DRV	6	3000	182.0	182.0	20.0
TPS70912DRVT	WSON	DRV	6	250	182.0	182.0	20.0
TPS709135DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS709135DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70915DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS70915DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70915DRVR	WSON	DRV	6	3000	200.0	183.0	25.0
TPS70915DRVR	WSON	DRV	6	3000	182.0	182.0	20.0
TPS70915DRVT	WSON	DRV	6	250	182.0	182.0	20.0
TPS70915DRVT	WSON	DRV	6	250	200.0	183.0	25.0
TPS70916DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS70916DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70918DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS70918DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70918DRVR	WSON	DRV	6	3000	182.0	182.0	20.0
TPS70918DRVRM3	WSON	DRV	6	3000	182.0	182.0	20.0

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS70918DRVT	WSON	DRV	6	250	182.0	182.0	20.0
TPS70919DBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TPS70919DBVT	SOT-23	DBV	5	250	210.0	185.0	35.0
TPS70925DBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TPS70925DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70925DRVR	WSON	DRV	6	3000	182.0	182.0	20.0
TPS70925DRVT	WSON	DRV	6	250	182.0	182.0	20.0
TPS70927DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS70927DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70928DBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TPS70928DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70930DBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TPS70930DBVT	SOT-23	DBV	5	250	210.0	185.0	35.0
TPS70930DRVR	WSON	DRV	6	3000	182.0	182.0	20.0
TPS70930DRVT	WSON	DRV	6	250	182.0	182.0	20.0
TPS70933DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS70933DBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TPS70933DBVT	SOT-23	DBV	5	250	210.0	185.0	35.0
TPS70933DRVR	WSON	DRV	6	3000	182.0	182.0	20.0
TPS70933DRVT	WSON	DRV	6	250	182.0	182.0	20.0
TPS70933DRVRM3	WSON	DRV	6	3000	182.0	182.0	20.0
TPS70933DRVT	WSON	DRV	6	250	182.0	182.0	20.0
TPS70936DBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TPS70936DBVT	SOT-23	DBV	5	250	210.0	185.0	35.0
TPS70936DBVT	SOT-23	DBV	5	250	210.0	185.0	35.0
TPS70936DRVR	WSON	DRV	6	3000	210.0	185.0	35.0
TPS70936DRVRM3	WSON	DRV	6	3000	182.0	182.0	20.0
TPS70938DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS70938DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70939DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS70939DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70950DBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TPS70950DBVT	SOT-23	DBV	5	250	210.0	185.0	35.0
TPS70950DRVR	WSON	DRV	6	3000	182.0	182.0	20.0
TPS70950DRVRM3	WSON	DRV	6	3000	182.0	182.0	20.0
TPS70950DRVT	WSON	DRV	6	250	182.0	182.0	20.0
TPS70960DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS70960DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS709A30DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS709A30DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS709A33DBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TPS709A33DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS709B33DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS709B33DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS709B345DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS709B50DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS709B50DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0

DBV0005A**PACKAGE OUTLINE****SOT-23 - 1.45 mm max height**

SMALL OUTLINE TRANSISTOR



4214839/K 08/2024

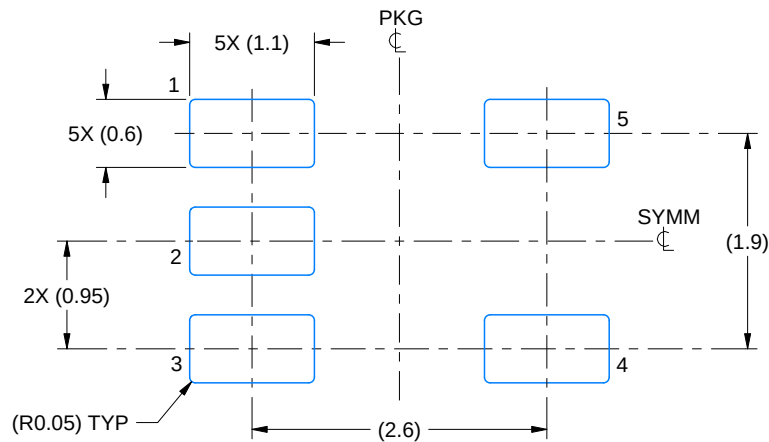
NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-178.
4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
5. Support pin may differ or may not be present.

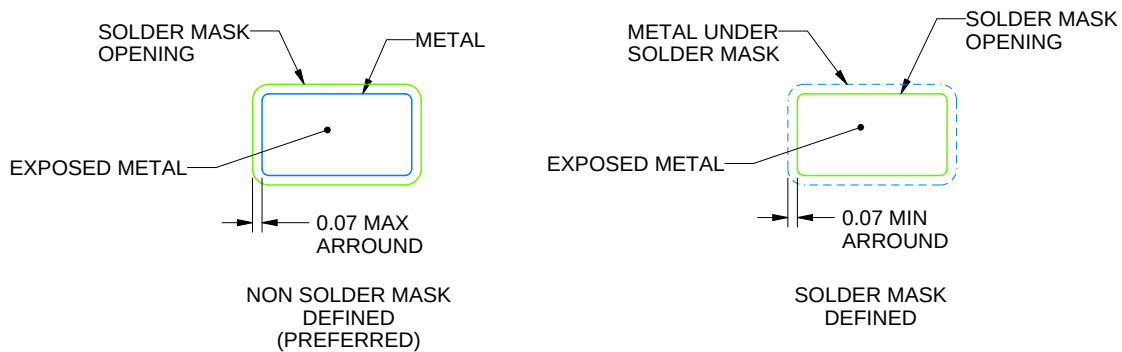
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:15X



SOLDER MASK DETAILS

4214839/K 08/2024

NOTES: (continued)

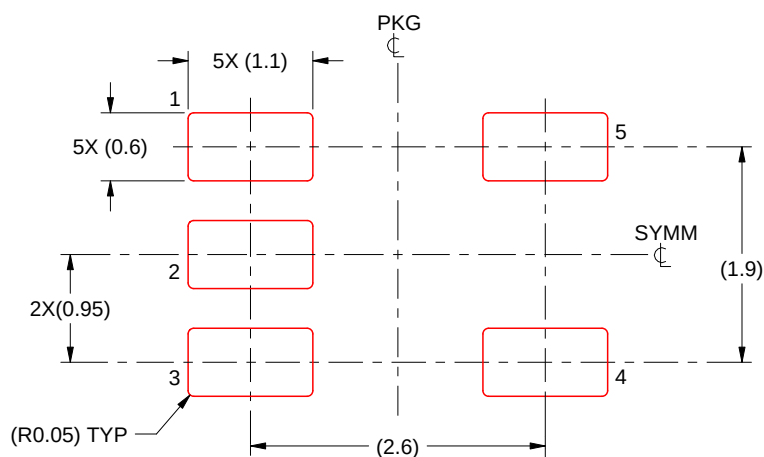
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR

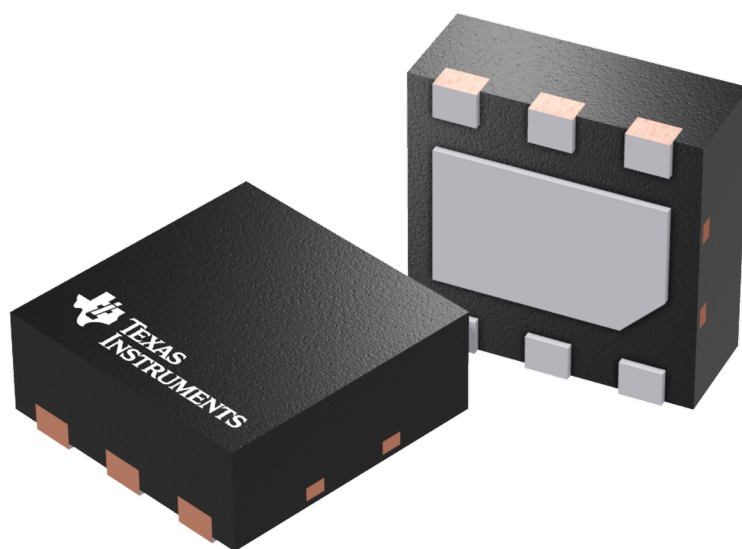


SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:15X

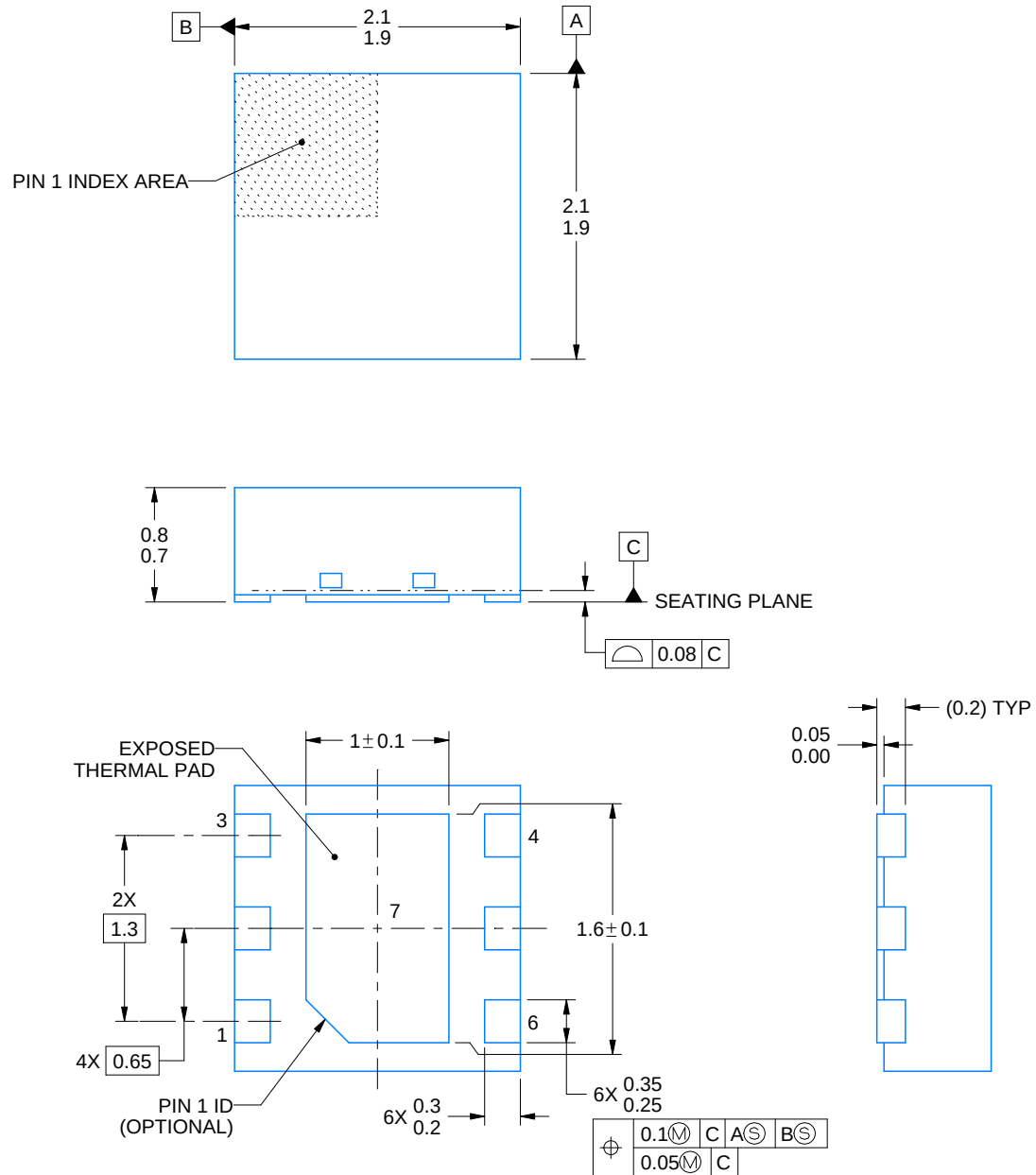
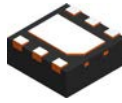
4214839/K 08/2024

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.



4222173/B 04/2018

NOTES:

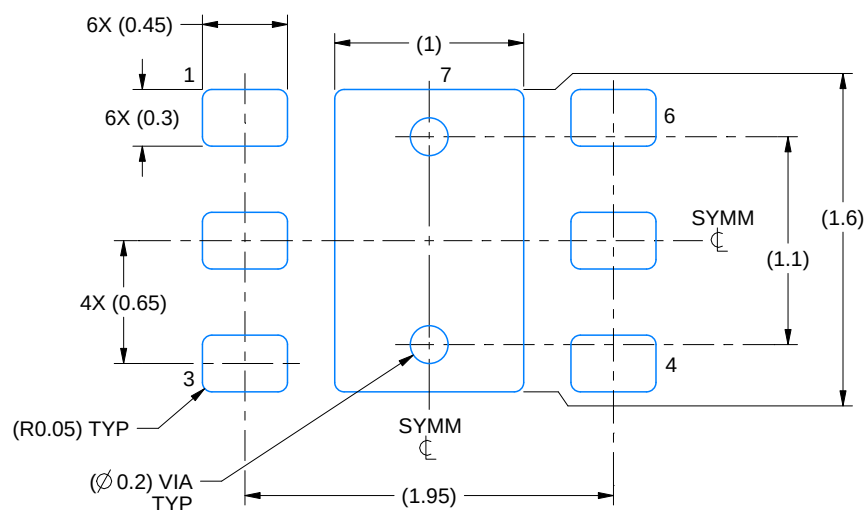
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

EXAMPLE BOARD LAYOUT

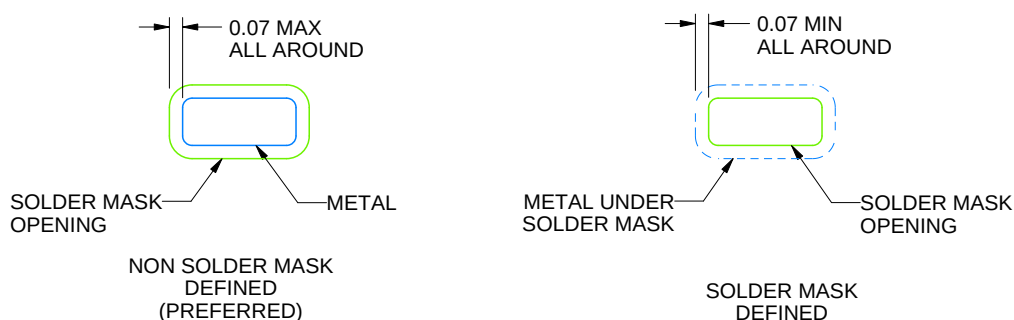
DRV0006A

WSN - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



LAND PATTERN EXAMPLE
SCALE:25X



SOLDER MASK DETAILS

4222173/B 04/2018

NOTES: (continued)

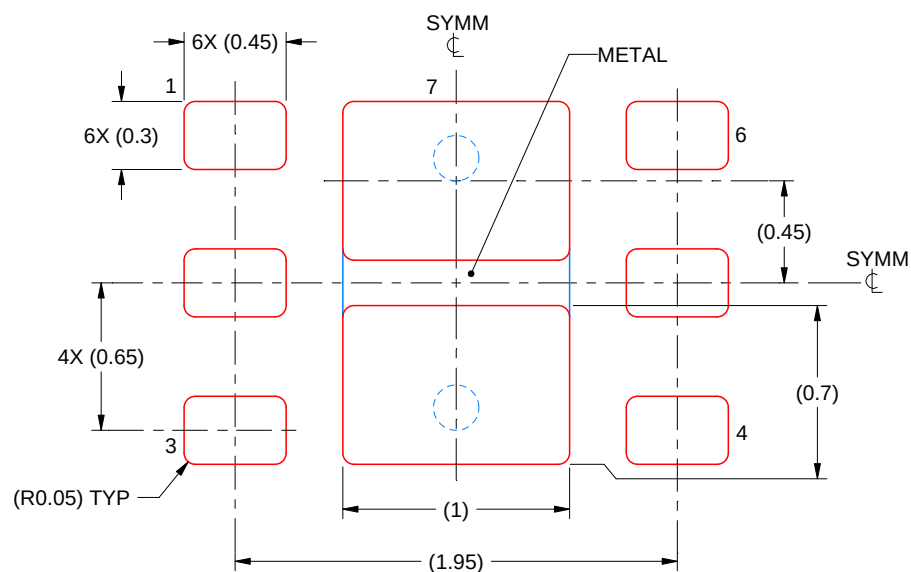
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slue271).
5. Vias are optional depending on application, refer to device data sheet. If some or all are implemented, recommended via locations are shown.

EXAMPLE STENCIL DESIGN

DRV0006A

WSO - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



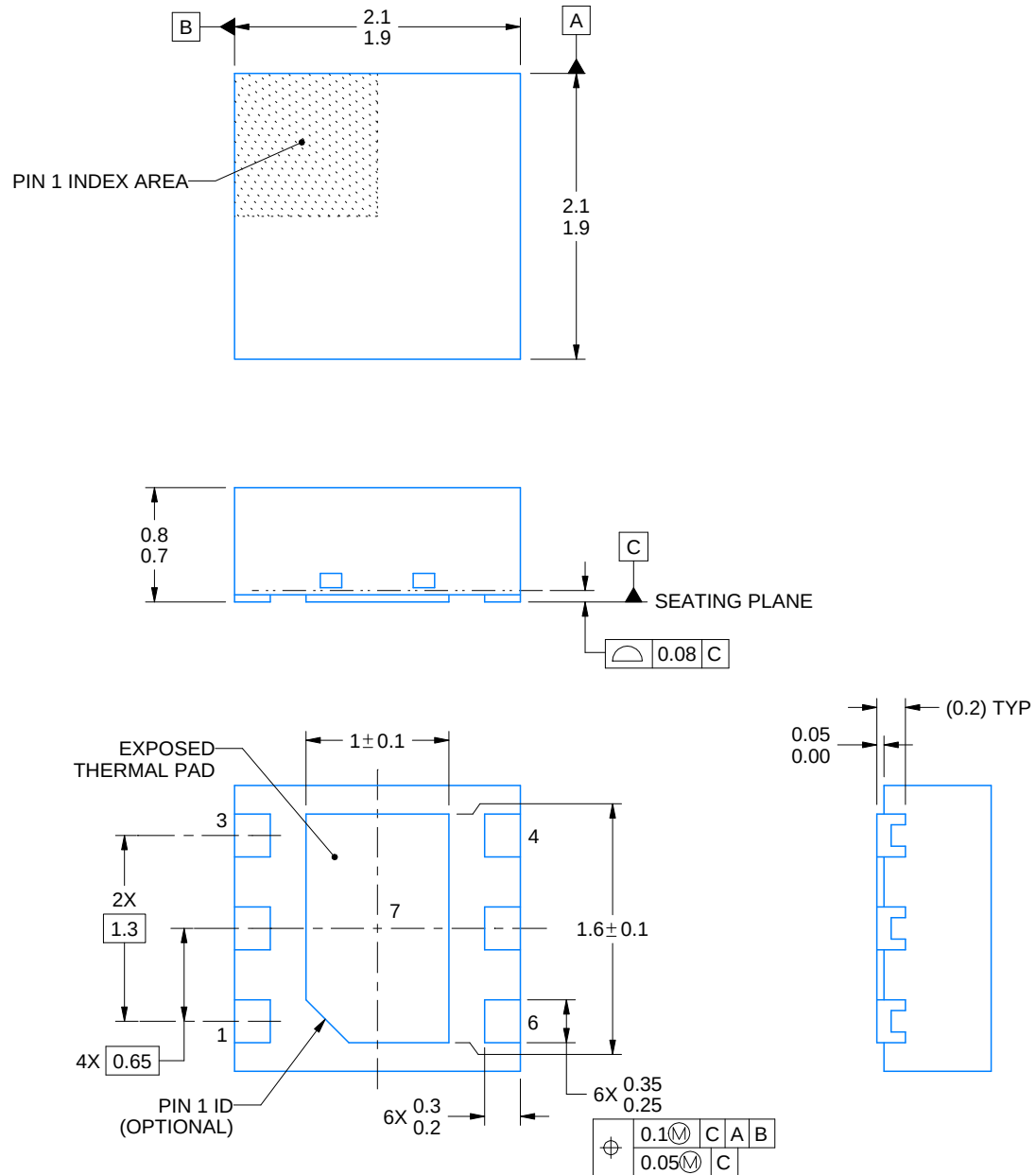
SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD #7
88% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
SCALE:30X

4222173/B 04/2018

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



4225563/A 12/2019

NOTES:

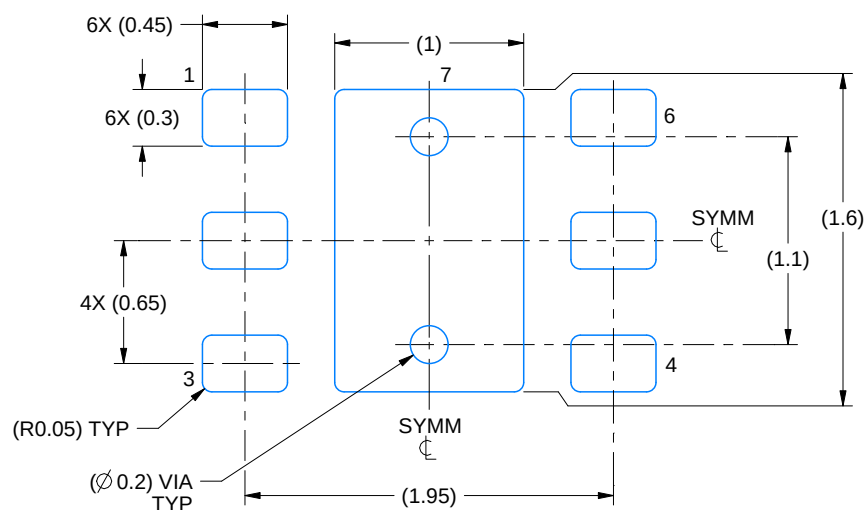
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

EXAMPLE BOARD LAYOUT

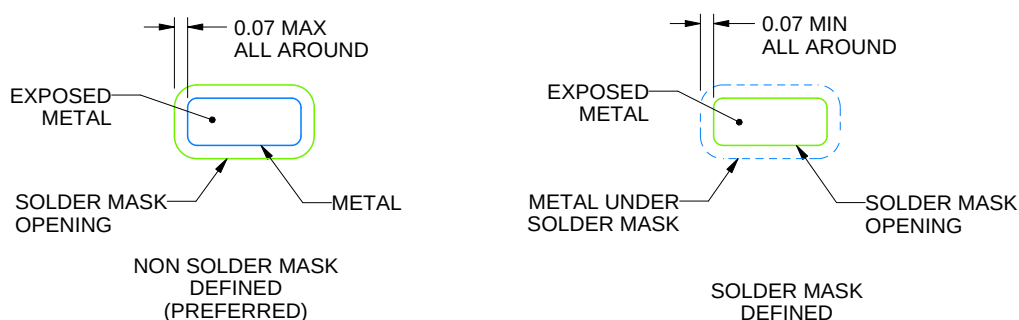
DRV0006D

WSO - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:25X



SOLDER MASK DETAILS

4225563/A 12/2019

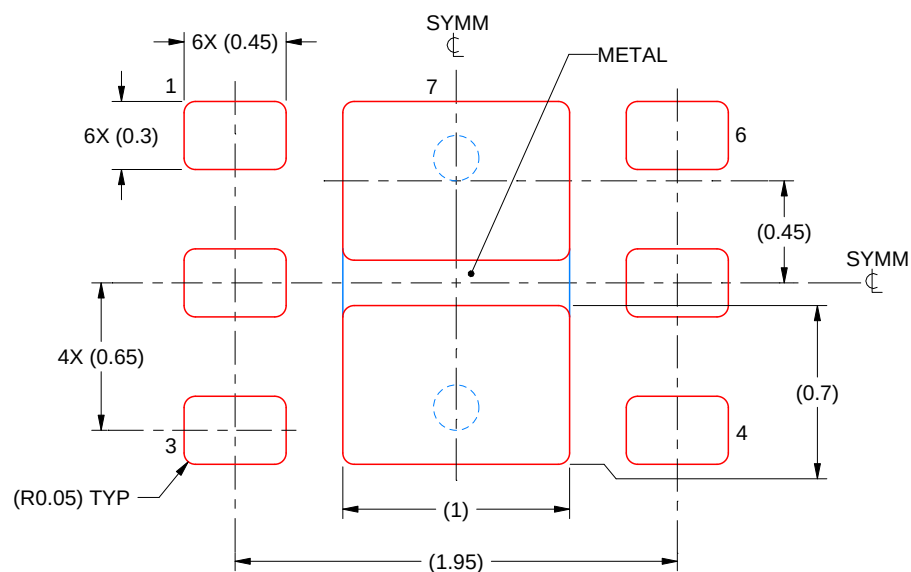
NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/sluea271).
5. Vias are optional depending on application, refer to device data sheet. If some or all are implemented, recommended via locations are shown.

DRV0006D

WSON - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



SOLDER PASTE EXAMPLE BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD #7
88% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
SCALE:30X

4225563/A 12/2019

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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